Petitioner Bluehouse Global Ltd.

Ex. 1006





US006784453B2

(12) United States Patent

Miyazaki et al.

(10) Patent No.: US 6,784,453 B2

(45) **Date of Patent:** Aug. 31, 2004

(54) SEMICONDUCTOR DEVICE AND METHOD FOR PRODUCING THE SAME

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(*) Notice: Subject to any disclaimer, the term of this

patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

(21) Appl. No.: 10/336,805

(22) Filed: Jan. 6, 2003

(65) **Prior Publication Data**

US 2003/0132482 A1 Jul. 17, 2003

Related U.S. Application Data

(62) Division of application No. 09/782,299, filed on Feb. 14, 2001, now Pat. No. 6,569,719, which is a division of application No. 08/635,283, filed on Apr. 19, 1996, now Pat. No. 6,201,281, which is a continuation of application No. 08/270,773, filed on Jul. 5, 1994, now abandoned.

(30) Foreign Application Priority Data

Jul. 7, 1993	(JP)	5-192829
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(51)	Int.	CL^7	 H01L	31	/0.3	\$6
(51) IIII.	CI.	 $\mathbf{n}_{\mathbf{U}\mathbf{I}\mathbf{L}}$	31,	/US	j

- (52) U.S. Cl. 257/49; 257/72; 257/347

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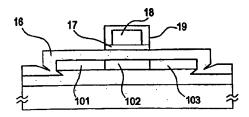
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(57) ABSTRACT

In the production of thin film transistor (TFT), a gate insulating film is formed to cover an active layer, a titanium nitride film is formed on the gate insulating film, and an aluminum film used as the gate electrode is formed on the titanium nitride film. The resulted configuration prevents the etching of the aluminum film from the insulating film side even if the etchant of aluminum enters the recessed portion at the edge of the active layer during the patterning of the gate electrode. Also in the anodizing process, when an oxide film is formed on the surface of the aluminum film, the oxidation of aluminum from the gate insulating film side is prevented even when the electrolyte solution enters the recessed portion at the edge of the active layer.

27 Claims, 4 Drawing Sheets





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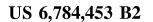


FIG. 1A

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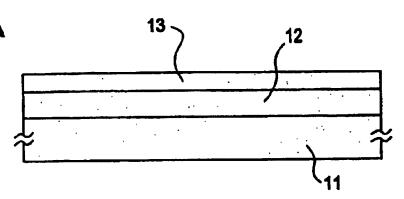


FIG. 1B

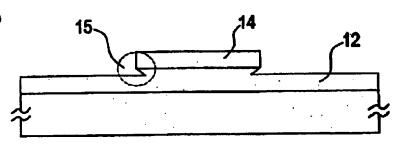


FIG. 1C

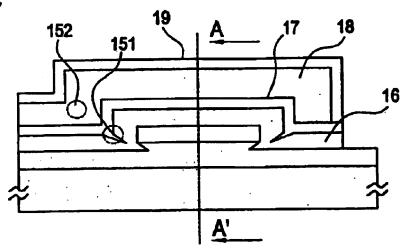
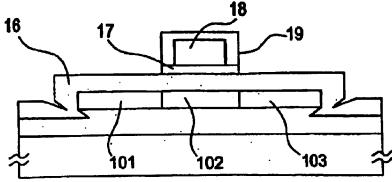
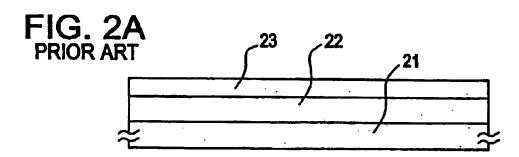


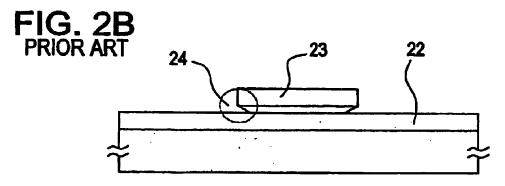
FIG. 1D

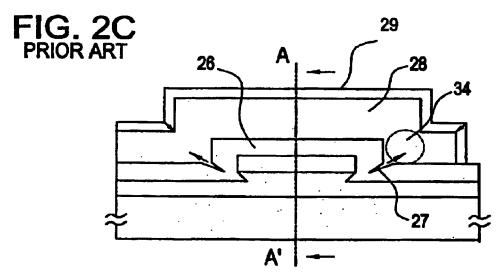


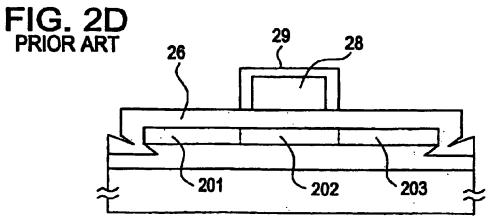




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